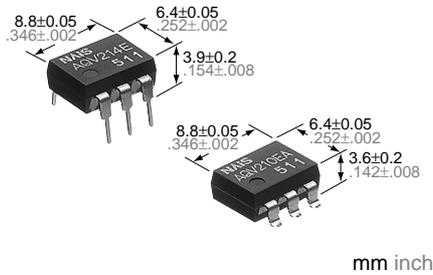


# NAIS

## GU (General Use)-E Type [1-Channel (Form A) Type]

# PhotoMOS RELAYS

### FEATURES



mm inch

- 1. Controls low-level analog signals**  
PhotoMOS relays feature extremely low closed-circuit offset voltage to enable control of low-level analog signals without distortion.
- 2. Control with low-level input signals**
- 3. Controls various types of loads such as relays, motors, lamps and solenoids.**
- 4. Optical coupling for extremely high isolation**  
Unlike mechanical relays, the PhotoMOS relay combines LED and optoelectronic device to transfer signals using light for extremely high isolation.
- 5. Eliminates the need for a counter electromotive force protection diode in the drive circuits on the input side**

- 6. Stable on resistance**
- 7. Low-level off state leakage current**
- 8. Eliminates the need for a power supply to drive the power MOSFET**  
A power supply used to drive the power MOSFET is unnecessary because of the built-in optoelectronic device. This results in easy circuit design and small PC board area.
- 9. Low thermal electromotive force (Approx. 1  $\mu$ V)**

### TYPICAL APPLICATIONS

- High-speed inspection machines
- Telephone equipment
- Data communication equipment
- Computer

### TYPES

Type	I/O isolation	Output rating*		Part No.				Packing quantity	
				Through hole terminal	Surface-mount terminal				
		Load voltage	Load current	Tube packing style		Tape and reel packing style		Tube	Tape and reel
AC/DC	Standard 1,500 V AC	350 V	130 mA	AQV210E	AQV210EA	AQV210EAX	AQV210EAZ		
		400 V	120 mA	AQV214E	AQV214EA	AQV214EAX	AQV214EAZ		
	Reinforced 5,000 V	350 V	130 mA	AQV210EH	AQV210EHA	AQV210EHAX	AQV210EHAZ		
		400 V	120 mA	AQV214EH	AQV214EHA	AQV214EHAX	AQV214EHAZ		

\*Indicate the peak AC and DC values.

Note: For space reasons, the package type indicator "X" and "Z" are omitted from the seal.

### RATING

#### 1. Absolute maximum ratings (Ambient temperature: 25°C 77°F)

Item		Sym- bol	Type of connec- tion	AQV210E(A)	AQV214E(A)	AQV210EH(A)	AQV214EH(A)	Remarks	
Input	LED forward current	$I_F$		50 mA					
	LED reverse voltage	$V_R$		3 V					
	Peak forward current	$I_{FP}$		1 A					$f = 100$ Hz, Duty factor = 0.1%
	Power dissipation	$P_{in}$		75 mW					
Output	Load voltage (peak AC)	$V_L$		350 V	400 V	350 V	400 V	A connection: Peak AC, DC; B, C connection: DC	
	Continuous load current	$I_L$		A	0.13 A	0.12 A	0.13 A		0.12 A
				B	0.15 A	0.13 A	0.15 A		0.13 A
				C	0.17 A	0.15 A	0.17 A		0.15 A
	Peak load current	$I_{peak}$		0.4 A	0.3 A	0.4 A	0.3 A		A connection: 100 ms (1 shot), $V_L=DC$
Power dissipation	$P_{out}$	500 mW							
Total power dissipation	$P_T$	550 mW							
I/O isolation voltage		$V_{iso}$		1,500 V AC		5,000 V AC			
Temperature limits	Operating	$T_{opr}$		-40°C to +85°C -40°F to +185°F				Non-condensing at low temp.	
	Storage	$T_{stg}$		-40°C to +100°C -40°F to +212°F					

# AQV210E

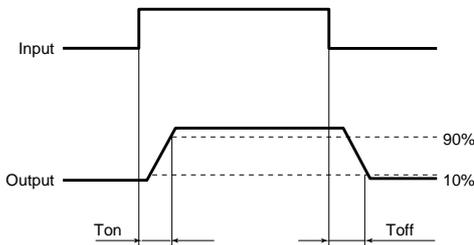
## 2. Electrical characteristics (Ambient temperature: 25°C 77°F)

Item		Symbol	Type of connection**	AQV210E(A)	AQV214E(A)	AQV210EH(A)	AQV214EH(A)	Condition	
Input	LED operate current	Typical	I <sub>Fon</sub>	—	1.1 mA	1.1 mA	1.6 mA	1.6 mA	I <sub>L</sub> = Max.
		Maximum			3 mA				
	LED turn off current	Minimum	I <sub>Foff</sub>	—	0.3 mA	0.3 mA	0.4 mA	0.4 mA	I <sub>L</sub> = Max.
Typical		1.0 mA			1.0 mA	1.5 mA	1.5 mA		
LED dropout voltage	Typical	V <sub>F</sub>	—	1.14 V (1.25 V at I <sub>F</sub> = 50 mA)				I <sub>F</sub> = 5 mA	
	Maximum			1.5 V					
Output	On resistance	Typical	R <sub>on</sub>	A	23 Ω	30 Ω	23 Ω	30 Ω	I <sub>F</sub> = 5 mA I <sub>L</sub> = Max. Within 1 s on time
		Maximum			35 Ω	50 Ω	35 Ω	50 Ω	
		Typical	R <sub>on</sub>	B	11.5 Ω	22.5 Ω	11.5 Ω	22.5 Ω	I <sub>F</sub> = 5 mA I <sub>L</sub> = Max. Within 1 s on time
		Maximum			17.5 Ω	25 Ω	17.5 Ω	25 Ω	
	Typical	R <sub>on</sub>	C	6.0 Ω	11.3 Ω	6.0 Ω	11.3 Ω	I <sub>F</sub> = 5 mA I <sub>L</sub> = Max. Within 1 s on time	
	Maximum			8.8 Ω	12.5 Ω	8.8 Ω	12.5 Ω		
Output capacitance	Typical	C <sub>out</sub>	A	45 pF				I <sub>F</sub> = 0 V <sub>S</sub> = 0 f = 1 MHz	
Off state leakage current	Maximum	—	—	1 μA				I <sub>F</sub> = 0 V <sub>L</sub> = Max.	
Transfer characteristics	Switching speed	Turn on time*	T <sub>on</sub>	—	0.5 ms	0.5 ms	0.7 ms	0.7 ms	I <sub>F</sub> = 5 mA** I <sub>L</sub> = Max.
		Maximum			2.0 ms	2.0 ms	2.0 ms	2.0 ms	
	Turn off time*	Typical	T <sub>off</sub>	—	0.05 ms				I <sub>F</sub> = 5 mA I <sub>L</sub> = Max.
		Maximum			1.0 ms				
	I/O capacitance	Typical	C <sub>iso</sub>	—	0.8 pF				f = 1 MHz V <sub>S</sub> = 0
Maximum		1.5 pF							
Initial I/O isolation resistance	Minimum	R <sub>iso</sub>	—	1,000 MΩ				500 V DC	

Note: Recommendable LED forward current  
Standard type: 5 mA  
Reinforced type: 5 to 10 mA

\*\*Type of connection, see Page 444.

\*Turn on/Turn off time



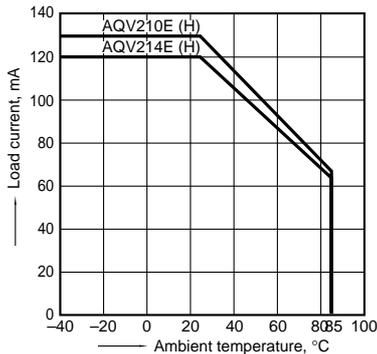
- For Dimensions, see Page 440.
- For Schematic and Wiring Diagrams, see Page 444.
- For Cautions for Use, see Page 449.

## REFERENCE DATA

### 1. Load current vs. ambient temperature characteristics

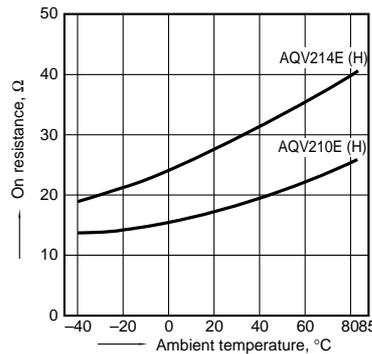
Allowable ambient temperature: -40°C to +85°C  
-40°F to +185°F

Type of connection: A



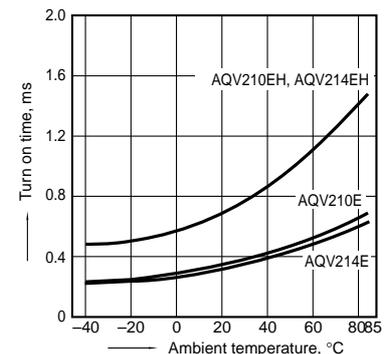
### 2. On resistance vs. ambient temperature characteristics

Measured portion: between terminals 4 and 6;  
LED current: 5 mA; Load voltage: Max. (DC);  
Continuous load current: Max. (DC)



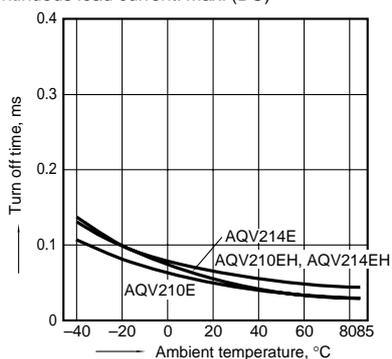
### 3. Turn on time vs. ambient temperature characteristics

LED current: 5 mA;  
Load voltage: Max. (DC);  
Continuous load current: Max. (DC)



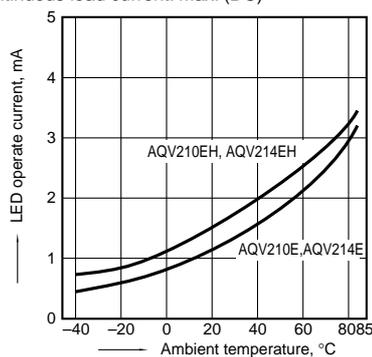
## 4. Turn off time vs. ambient temperature characteristics

LED current: 5 mA; Load voltage: Max. (DC);  
Continuous load current: Max. (DC)



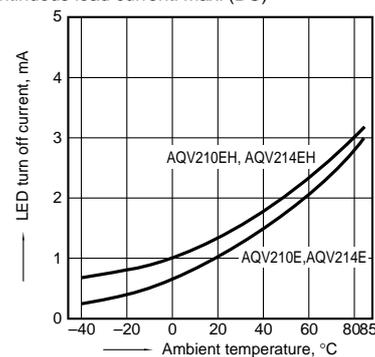
## 5. LED operate current vs. ambient temperature characteristics

Load voltage: Max. (DC);  
Continuous load current: Max. (DC)



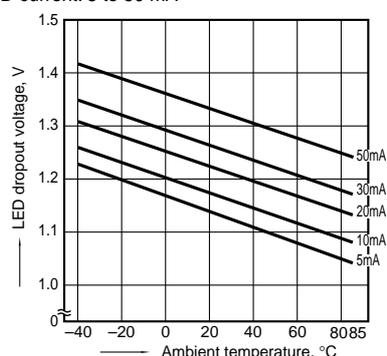
## 6. LED turn off current vs. ambient temperature characteristics

Load voltage: Max. (DC);  
Continuous load current: Max. (DC)



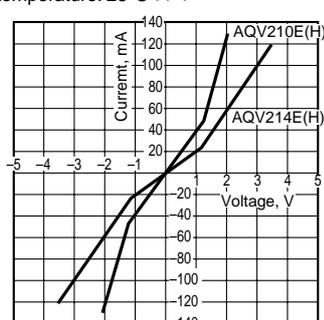
## 7. LED dropout voltage vs. ambient temperature characteristics

Sample: All types  
LED current: 5 to 50 mA



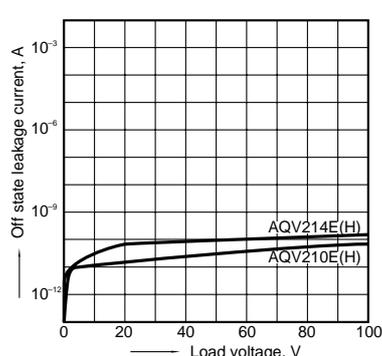
## 8. Voltage vs. current characteristics of output at MOS portion

Measured portion: between terminals 4 and 6;  
Ambient temperature: 25°C 77°F



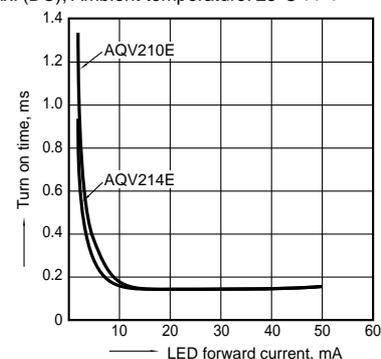
## 9. Off state leakage current

Measured portion: between terminals 4 and 6;  
Ambient temperature: 25°C 77°F



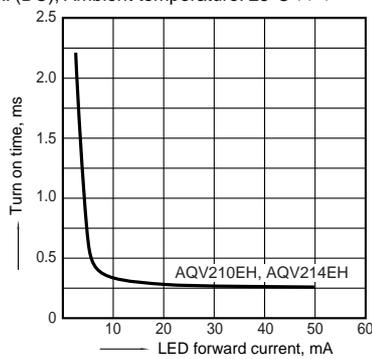
## 10-(1). LED forward current vs. turn on time characteristics

Measured portion: between terminals 4 and 6;  
Load voltage: Max. (DC); Continuous load current: Max. (DC); Ambient temperature: 25°C 77°F



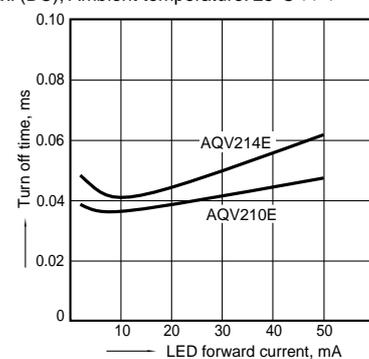
## 10-(2). LED forward current vs. turn on time characteristics

Measured portion: between terminals 4 and 6;  
Load voltage: Max. (DC); Continuous load current: Max. (DC); Ambient temperature: 25°C 77°F



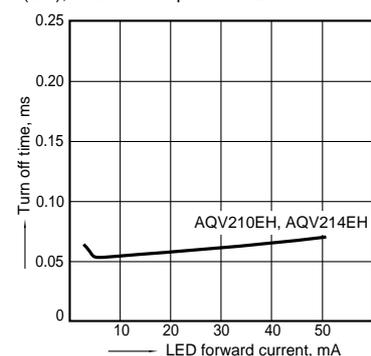
## 11-(1). LED forward current vs. turn off time characteristics

Measured portion: between terminals 4 and 6;  
Load voltage: Max. (DC); Continuous load current: Max. (DC); Ambient temperature: 25°C 77°F



## 11-(2). LED forward current vs. turn off time characteristics

Measured portion: between terminals 4 and 6;  
Load voltage: Max. (DC); Continuous load current: Max. (DC); Ambient temperature: 25°C 77°F



## 12. Applied voltage vs. output capacitance characteristics

Measured portion: between terminals 4 and 6;  
Frequency: 1 MHz;  
Ambient temperature: 25°C 77°F

